505648280 08/30/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5695086

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YUICHI YAMADA	08/20/2019

RECEIVING PARTY DATA

Name:	SONY OLYMPUS MEDICAL SOLUTIONS INC.
Street Address:	4-7-1, KOYASU-MACHI,
Internal Address:	HACHIOJI-SHI,
City:	TOKYO
State/Country:	JAPAN
Postal Code:	1920904

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16490079

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (571) 376-6333

Email: anaquadocketing@Xsensus.com

Correspondent Name: XSENSUS LLP

Address Line 1: 200 DAINGERFIELD ROAD

Address Line 2: SUITE 201

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	13009US01
NAME OF SUBMITTER:	TIERNEY FARRELL
SIGNATURE:	/Tierney Farrell/
DATE SIGNED:	08/30/2019
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 1

source=13009US01_Assignment#page1.tif

PATENT 505648280 REEL: 050238 FRAME: 0330

Attorney Docket No.: Sony Ref. No.: SP369076US00

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	MEDICAL APPARATUS AND METHOD OF MANUFACTURING MEDICAL APPARATUS	
As the below	named inventor, I hereby declare that:	
This declarat is directed to	The attacked multimeter in	
	United States application or PCT international application number PCT/JP2017/038576 filed on 2017/10/25	
The above-identified application was made or authorized to be made by me.		
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. WHEREAS, Sony Olympus Medical Solutions Inc. with offices at 4-7-1 Koyasu-machi Hachioji-shi, Tokyo Japan JAPAN (hereinafter referred to as ASSIGNEE), is desirous of		
acquiring all	interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar ion which may be granted therefor in the United States and in any and all foreign countries;	
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;		
designee, as remuneration	r agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further i, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of tates and countries foreign thereto;	
application f	er agree to properly execute and deliver and without fiather remumeration, such necessary or desirable and lawful papers for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters among the granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense:	
application,	er agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will the same in any interference or litigation related thereto;	
	covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with ent and sale.	
	nowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of in five (5) years, or both.	
LEGAL NA	ME OF INVENTOR	
Inventor:	YUICHI YAMADA Date: 20/9, 8, 20	
Signature:	Michi Gamada	

PATENT REEL: 050238 FRAME: 0331

RECORDED: 08/30/2019